

TAILORED TO SPECIFICATIONS

- Fully Customizable to Match Satellite Platform and Payload Requirements
- One High Efficiency Main Output + Two Low Noise Auxiliary Outputs
- Onboard EMC Filters Ensures Compliance Without Additional Filtering
- Input to Output Power Efficiency of up to 93%

FEATURE-RICH

- User Adjustable Voltage for Output 1
- Output Over Voltage Protection
- Active Discharge of Output 1 During Command OFF
- Output ON/OFF Sequencing
- Telecommand Interface and Telemetries



Micross EGB converters offer state of the art performance and is specifically designed for RF GaN SSPA applications. The EGB provides excellent efficiency and low CE, and can be tailored to the specific spacecraft bus and equipment requirements.

RAD-HARD, ITAR FREE
100 kRad and 60 MeV

Design Expertise

Micross' design team helps review and specify payload specific DC-DC converters to ensure maximum compatibility and minimum risk at equipment level. We design, develop, manufacture and test complete DC-DC solutions for effortless payload integration.

Design Flexibility

The EGB converters can be tailored to most satellite platforms and the outputs can be configured to customer specific payload requirements.

Output 1:	+30V to +60V	180W
Output 2:	+2.5V to +15V	1A or 6W max
Output 3:	-2.5V to -15V	1A or 5W max

Rapid Delivery for Tailored Designs:

- 6 Months for Engineering Models
- 9 Months for CDR Datapackage
- 12 Months for Flight Units

Design Datapackage

- Worst Case Analysis
- Radiation Analysis
- Part Stress Analysis
- Reliability Assessment
- Thermal Analysis
- FMECA
- Mechanical Analysis
- Declared Components List
- Declared Process List
- Declared Materials List

Product Control Documentation

- Interface Schematics
- Interface Control Drawing
- User's Manual
- Test Plan
- Acceptance Test Procedure
- EMC Test Procedure and Report
- EIDP (One for Each Deliverable Item)
- Micross Standard Product Assurance Plan
- Compliance Statement for Specification
- Configuration Status List
- SET and Loop Stability Test Reports

Mechanical

PCB Outline Excl. Connectors	Mass
EGBN: 124.2mm x 84.7mm x 23.6mm	< 225g
EGBL: 155mm x 70mm x 23.5mm	< 250g
EGB: 153mm x 95mm x 25.0mm	< 300g

Electrical Performance

- WC EOL Output Voltage Accuracy: $\pm 2\%$ Including Line and Load
- Load Step Transient Response: $\pm 5\%$ for a 50% to 100% Load Step

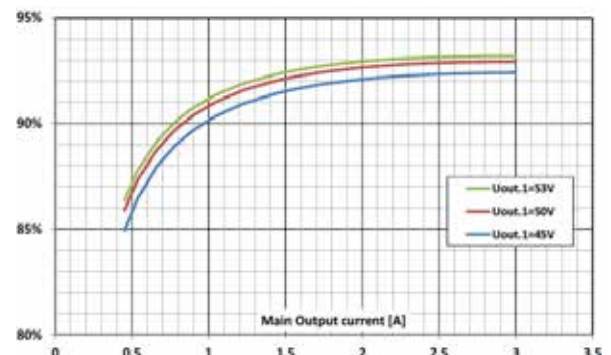
Output CE:

- V1 and V2: < 10.0mVrms (50Hz to 50MHz)
- V3 and V4: < 1.0mVrms (50Hz to 50MHz)

CS Rejection Input to Outputs:

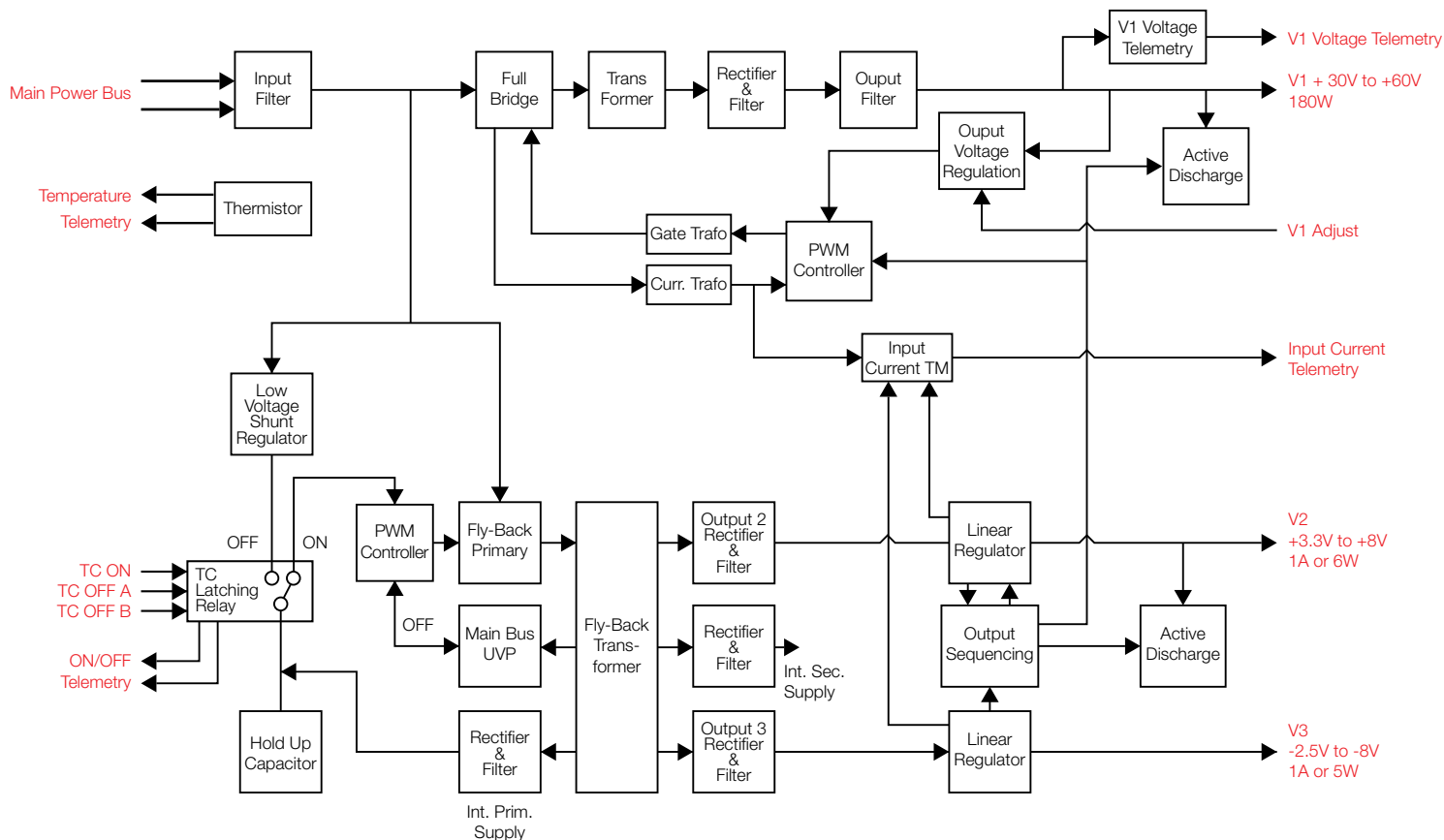
- V1 and V2: > 40dB
- V3 and V4: > 85dB

Typical Efficiency



All 4 Outputs Loaded Equal Relative to Max Load

EGB Series Generic Block Schematic



Flight Qualified and Export Approved Configurations

Series	Part Number	Input Voltage	V1	V2	V3
EGBN	12177	95V - 103V	42.0V / 1.87A	5.0V / 0.20A	-5.0V / 0.13A
EGBL	12123	32V - 37.5V	53.0V / 3.50A	5.0V / 0.20A	-5.0V / 0.13A
	12202	33.1V - 37V	53.0V / 3.00A	5.2V / 0.40A	-5.2V / 0.13A
EGB	12161	98V - 101V	53.0V / 3.50A	5.0V / 0.20A	-5.0V / 0.13A
	12194	98V - 101V	42.0V / 3.81A	5.0V / 0.31A	-5.0V / 0.13A
	12196	22V - 35V	45.0V / 2.20A	8.0V / 0.70A	-6.0V / 0.10A

ECCN: 9A515.y.1

About Micross

Micross is the most complete provider of advanced microelectronic services and component, die and wafer solutions. With the broadest authorized access to die & wafer suppliers, an extensive portfolio of hi-rel power, RF, optoelectronics, memory, data bus, logic, and SMD/5962 qualified products, and the most comprehensive advanced packaging, assembly, modification, upscreening, and test capabilities, Micross is uniquely positioned to provide unparalleled high-reliability solutions, from bare die, to fully packaged devices including hermetic ICs/MCMs, PEMS, ASICs, FPGAs, and PCBs, to complete program life-cycle sustainment. For more than 45 years, Micross has been a trusted source for the aerospace, defense, space, medical, energy, communications, and industrial markets.



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